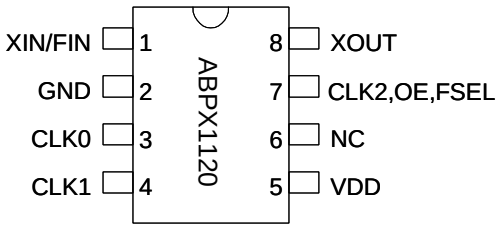
ABPX1120

Advanced Programmable Clock

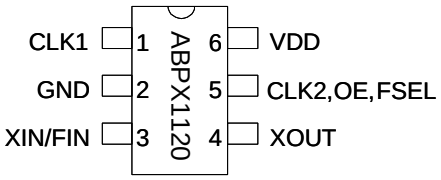
FEATURES

- Advanced programmable PLL design
- Very low Jitter and Phase Noise (< 40ps Pk-Pk typical)
- Up to 3 outputs
- Two registers banks for 2-time programming.
- Output frequency up to 200MHz CMOS.
- Crystal inputs:
  - Fundamental crystal: 10MHz-30MHz
  - 3RD overtone crystal: Up to 75MHz
- Accepts <1.0V reference signal input voltage
- One programmable I/O pin can be configured as Output Enable (OE), or Frequency Selection input (FSEL), or Reference clock.
- Single 2.5V or 3.3V ± 10% power supply
- Operating temperature range from -40°C to 85°C
- Available in 8-pin MSOP/SOIC, 6-pin SOT Green/ RoHS compliant packages

PIN CONFIGURATION



SOP-8
MSOP-8

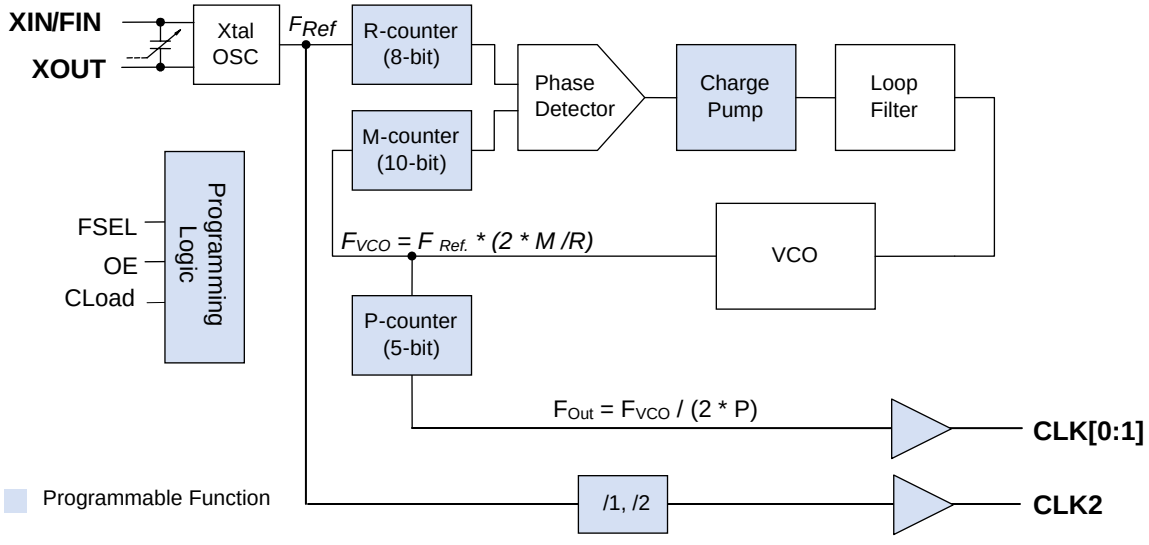


SOT-23

DESCRIPTION

The ABPX1120 is a low-cost general purpose frequency synthesizer and a member of Abracon's Advanced Programmable Clock family. Abracon's ABPX1120 product family can generate any output frequency up to 200 MHz from fundamental crystal input between 10 MHz - 30 MHz, or a 3rd overtone crystal of up to 75Mhz.

BLOCK DIAGRAM



KEY PROGRAMMING PARAMETERS

CLK[0:2] Output Frequency	Output Drive Strength	Crystal Load	Programmable Input/Output (pin #7)	# of Register Banks	Charge-Pump Current
Fout = FIN * M / (R * P) where M=10 bit R= 8 bit P= 5 bit 1. CLK[0:1]= VCO / 2 * P 2. CLK[2]= FIN or FIN/2	Std: 10mA (default) High: 24mA	+/- 200ppm tuning.	One output pin can be configured as 1. CLK2 = FIN or FIN/2 2. FSEL - input 3. OE - input	2	4 levels of pump current setting

PIN DESCRIPTION

Name	Pin #		Type	Description
	(M)SOP-8	SOT-23		
XIN/FIN	1	3	I	Crystal or Reference input pin
GND	2	2	P	GND connection
CLK[0:1]	3,4	1	O	Programmable Clock Output [note:CLK0=CLK1]
VDD	5	6	P	VDD connection (2.25~3.63V)
DNC	6	-	-	Do No Connect
CLK2, OE, FSEL	7	5	B	This programmable I/O pin can be configured as CLK2 (FIN or FIN/2) output, or OE input, or Frequency Selection (FSEL) input pin. This pin has an internal 60KΩ pull up resistor.
XOUT	8	4	O	Crystal output pin

State	OE	FSEL
0	Tristate CLK[0:1]	Select Bank '0' ROM
1 (default)	Normal mode	Select Bank '1' ROM

PAD ASSIGNMENT and DESCRIPTION

Name	Die Pads			Type	Description
	Pad #	X (µm)	Y(µm)		
XIN	1	101.5	1274.0	I	Crystal input.
GND	2	101.5	1075.0	P	GND connection.
	3	101.5	878.4		
CLK0	4	101.5	671.8	O	Optional same frequency clock output (CLK0=CLK1). If the clock output is not used, the pad should remain as 'Do Not Connect (DNC).
CLK1	5	101.5	425.0	O	Programmable Clock Output.
VDD	6	697	483.0	P	VDD connection.
VDD	7	697	790.0		
CLK2, OE, FSEL	8	697	1024.0	O	This programmable I/O pin can be configured as CLK2 (FIN or FIN/2) output, or OE input, or Frequency Selection (FSEL) input pin. This pin has an internal 60KΩ pull up resistor.
XOUT	9	697	1274.0	O	Crystal output.

State	OE	FSEL
0	Tristate CLK[0:1]	Select Bank '0' ROM
1 (default)	Normal mode	Select Bank '1' ROM

ELECTRICAL SPECIFICATIONS

ABSOLUTE MAXIMUM RATINGS

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage Range	V_{DD}	-0.5	4.6	V
Input Voltage Range	V_I	-0.5	V_{DD}+0.5	V
Output Voltage Range	V_O	-0.5	V_{DD}+0.5	V
Data Retention @ 85º C		10		Years
Soldering Temperature (Green Package)			260	°C
Storage Temperature	T_S	-65	150	°C
Ambient Operating Temperature*		-40	+85	°C

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

AC SPECIFICATIONS

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Crystal Input Frequency	Fundamental Crystal	10		30	MHz
	3rd Overtone Crystal			75	MHz
Settling Time	At power-up (after VDD increases over 1.62V)			10	ms
VDD Sensitivity	Frequency vs. VDD+/-10%	-2		2	ppm
Output Rise Time	15pF Load, 10/90%VDD, Standard drive		2.5	3.5	ns
	15pF Load, 10/90%VDD, High drive		1.0	1.5	ns
Output Fall Time	15pF Load, 90/10%VDD, Standard drive		2.5	3.5	ns
	15pF Load, 90/10%VDD, High drive		1.0	1.5	ns
Duty Cycle	At VDD/2	45	50	55	%
Max. output skew between same frequency clocks	Equal loading (15 pF). Equal frequency & drive strength			500	ps
Period Jitter, peak-to-peak* (measured from 10,000 samples)	With capacitive decoupling between VDD and GND. Operating only one output.		40		ps

* Note: Jitter performance depends on the programming parameters.

DC SPECIFICATIONS

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Current, Dynamic, with Loaded Outputs	I_{DD}	At 10MHz, load=15pF			15	mA
Operating Voltage	V_{DD}		2.25		3.63	V
Output Low Voltage	V_{OL}	I_{OL} = +4mA (Standard drive)			0.4	V
Output High Voltage	V_{OH}	I_{OH} = -4mA (Standard drive)	V_{DD} – 0.4			V
Output Current	I_{OSD}	V_{OL} = 0.4V, V_{OH} = 2.4V (Standard drive)		10		mA
	I_{OHD}	V_{OL} = 0.4V, V_{OH} = 2.4V (High Drive)		24		mA
Short-circuit Current	I_S			±50		mA

CRYSTAL SPECIFICATIONS

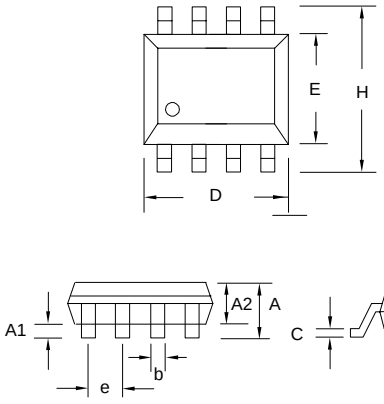
PARAMETERS	SYMBOL	MIN.	TYP.	MAX.	UNITS
Fundamental Crystal Resonator Frequency	F_{XIN}	10		30	MHz
3rd Overtone Crystal Resonator Frequency	F_{XIN}			75	MHz
Crystal Loading Rating (The IC can be programmed for any value in this range.)	$C_{L\ (xtal)}$	5		20	pF
Maximum Sustainable Drive Level				500	µW
Operating Drive Level			100		µW
Crystal Shunt Capacitance	C0			6	pF
Effective Series Resistance, Fundamental, 10-30MHz	R_S			30	Ω
Effective Series Resistance, 3rd Overtone, 30-50MHz [CO< 4pF, C_L=5pF/8pF]	ESR			100/70	Ω
Effective Series Resistance, 3rd Overtone, 50-65MHz, [CO< 4pF, C_L=5pF/8pF]	ESR			60/40	Ω
Effective Series Resistance, 3rd Overtone, 65-75MHz [CO< 4pF, C_L=5pF/8pF	ESR			45/30	Ω

Note: A detailed crystal specification document is also available for this part

PACKAGE DRAWINGS (GREEN PACKAGE COMPLIANT)

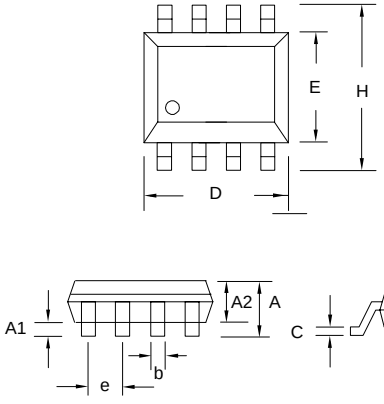
MSOP 8L

Symbol	Dimension in MM	
	Min.	Max.
A	---	1.10
A1	0.05	0.15
A2	0.81	0.91
B	0.25	0.40
C	0.13	0.23
D	2.90	3.10
E	2.90	3.10
H	4.90 BSC	
L	0.445	0.648
e	0.65 BSC	



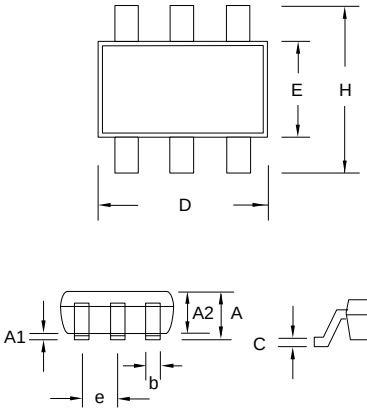
SOP 8L

Symbol	Dimension in MM	
	Min.	Max.
A	1.35	1.75
A1	0.10	0.25
A2	1.25	1.50
B	0.33	0.53
C	0.19	0.27
D	4.80	5.00
E	3.80	4.00
H	5.80	6.20
L	0.40	0.89
e	1.27 BSC	



SOT-23 6 L

Symbol	Dimension in MM	
	Min.	Max.
A	1.05	1.35
A1	0.05	0.15
A2	1.00	1.20
B	0.30	0.50
C	0.08	0.20
D	2.80	3.00
E	1.50	1.70
H	2.60	3.0
L	0.35	0.55
e	0.95 BSC	



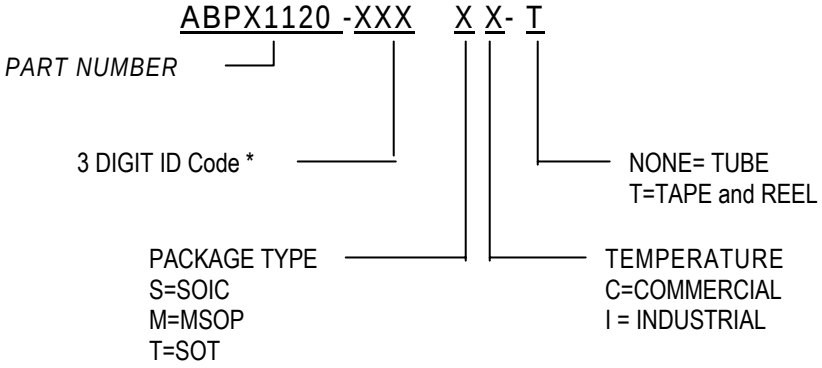
ORDERING INFORMATION

For part ordering, please contact our Sales Department:

30332 Esperanza., Rancho Santa Margarita, Ca 92688
Ph: 949-546-8000 Fax: 949-546-8001

PART NUMBER

The order number for this device is a combination of the following:
Device number, Package type and Operating temperature range



* Abracon will assign a unique 3-digit ID code for each approved programmed part number.
* Abracon offers Green Package Only for this product family.

Part / Order Number	Marking	Package Option
ABPX1120-XXXSC	A2XXX	8-Pin SOIC (Tube)
ABPX1120-XXXSC-T	A2XXX	8-Pin SOIC (Tape and Reel)
ABPX1120-XXXMC	A2XXX	8-Pin MSOP (Tube)
ABPX1120-XXXMC-T	A2XXX	8-Pin MSOP (Tape and Reel)
ABPX1120-XXXTC-T	A2XXX	6-Pin SOT-23 (Tape and Reel)